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MTP PressFit Power Module Three Phase Bridge, 45 A to 100 A



PRIMARY CHARACTERISTICS				
I _O	45 A to 100 A			
V _{RRM}	1600 V			
Package	MTP PressFit			
Circuit configuration	Three phase bridge			

FEATURES

- Low V_F
- · Low profile package
- Direct mounting to heatsink
- PressFit pins technology
- · Low junction to case thermal resistance
- 3500 V_{RMS} insulation voltage
- Designed and qualified for industrial level
- PressFit pins locking technology PATENT(S): www.vishav.com/patents
- UL approved file E78996
- Material categorization: for definitions of compliance please see www.vishav.com/doc?99912

APPLICATIONS

- · Power conversion machines
- Welding
- UPS
- SMPS
- Motor drives
- General purpose and heavy duty application

DESCRIPTION

The new MTP module is easy to use thanks to solder less method for contacting PressFit pins to the PCB. The low profile package has been specifically conceived to maximize space saving and optimize the electrical layout of the application specific power supplies.

MAJOR RATINGS AND CHARACTERISTICS						
SYMBOL	CHARACTERISTICS	VALUES 40MT	VALUES 70MT	VALUES 100MT	UNITS	
1		45	75	100	А	
I _O	T _C	100	80	80	°C	
1	50 Hz	270	380	450	Α	
I _{FSM}	60 Hz	280	398	470		
l ² t	50 Hz	365	724	1013	.2	
1-1	60 Hz	325	660	920	– A ² s	
$I^2\sqrt{t}$		3650	7240	10 130	A²√s	
V _{RRM}		1600			V	
T _{Stg}	Dange	- 40 to + 150			- °C	
T _J	Range		- 40 to + 150			

PATENT(S): www.vishay.com/patents

This Vishay product is protected by one or more United States and international patents.



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ELECTRICAL SPECIFICATIONS

VOLTAGE RATINGS						
TYPE NUMBER	VOLTAGE CODE REVERSE VOLTAGE V	V _{RRM} , MAXIMUM REPETITIVE PEAK REVERSE VOLTAGE V	V _{RSM} , MAXIMUM NON-REPETITIVE PEAK V	I _{RRM} MAXIMUM AT T _J = 150 °C mA		
VS-40MT160P-P, VS-70MT160P-P, VS-100MT160P-P	160	1600	1700	5		

FORWARD CONDUCTION								
PARAMETER	SYMBOL		TEST CONDITIONS			VALUES 70MT	VALUES 100MT	UNITS
Maximum DC output	lo	120° rect to	conduction angle		45	75	100	Α
current at case temperature	10	120 1601.10	conduction angle		100	80	80	°C
		t = 10 ms	No voltage		270	380	450	
Maximum peak, one cycle forward, non-repetitive on	l	t = 8.3 ms	reapplied		280	398	470	
state surge current	IFSM	I _{FSM} t = 10 ms 100 % V _{RRM}		225	320	380	A	
		t = 8.3 ms	reapplied	Initial	240	335	400	
		t = 10 ms	$ \begin{array}{c} \text{No voltage} \\ \text{reapplied} \end{array} T_J = T_J $	$T_J = T_J$ maximum	365	724	1013	- A ² s
Maximum I ² t for fusing	l ² t	t = 8.3 ms			325	660	920	
waximum i-t for fusing	I-t	t = 10 ms	100 % V _{RRM}		253	512	600	A-S
		t = 8.3 ms	reapplied		240	467	665	
Maximum I ² √t for fusing	I²√t	t = 0.1 ms to	t = 0.1 ms to 10 ms, no voltage reapplied			7240	10 130	A²√s
Value of threshold voltage	V _{F(TO)}	T mayimum	T			0.82	0.75	V
Slope resistance	r _t	T _J maximum		14.8	9.5	8.1	mΩ	
Maximum forward voltage drop	V _{FM}	$T_J = 25 ^{\circ}\text{C}; t_p$ (40MT, $I_{pk} = 4$	$T_J = 25$ °C; $t_p = 400 \mu s$ single junction (40MT, $I_{pk} = 40 A$) (70MT, $I_{pk} = 70 A$) (100MT, $I_{pk} = 100 A$)		1.45	1.45	1.51	V

INSULATION TABLE						
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES 40MT	VALUES 70MT	VALUES 100MT	UNITS
RMS insulation voltage	V _{INS}	$T_J = 25$ °C, all terminal shorted, $f = 50$ Hz, $t = 1$ s		3500		V

THERMAL AND MECHANICAL SPECIFICATIONS							
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES 40MT	VALUES 70MT	VALUES 100MT	UNITS	
Maximum junction operating temperature range	TJ		- 40 to + 150		0	°C	
Maximum storage temperature range	T _{Stg}		-	- 40 to + 150			
	R _{thJC}	DC operation per module	0.27	0.23	0.19		
Maximum thermal resistance,		DC operation per junction	1.6	1.38	1.14		
junction to case		120° rect. conduction angle per module	0.38	0.29	0.22		
		120° rect. conduction angle per junction	2.25	1.76	1.29	K/W	
Maximum thermal resistance, case to heatsink per module		Mounting surface smooth, flat and greased heatsink compound thermal conductivity = 0.42 W/mK	0.1				
Mounting torque to heatsink± 10 % Approximate weight		A mounting compound is recommended	4		Nm		
		and the torque should be rechecked after a period of 3 hours to allow for the spread of the compound. Lubricated threads	65		g		



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CLEARANCE AND CREEPAGE DISTANCES						
PARAMETER	TEST CONDITIONS	MTP PressFit	UNITS			
Clearance	External shortest distances in air between terminals which are not internally short circuited together	10.2	mm			
Creepage distance	Shortest distance along external surface of the insulating material between terminals which are not internally short circuited together	13				

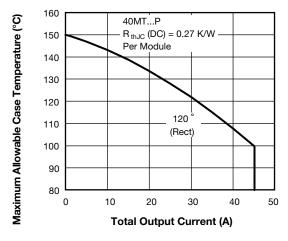


Fig. 1 - Current Rating Characteristics

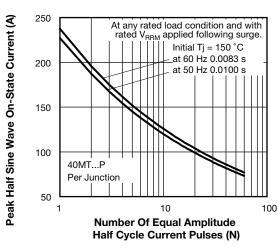


Fig. 3 - Maximum Non-Repetitive Surge Current

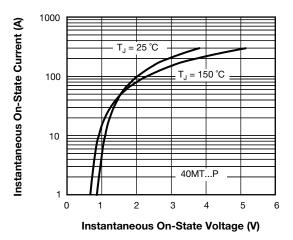


Fig. 2 - On-State Voltage Drop Characteristics

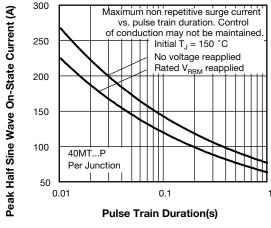


Fig. 4 - Maximum Non-Repetitive Surge Current

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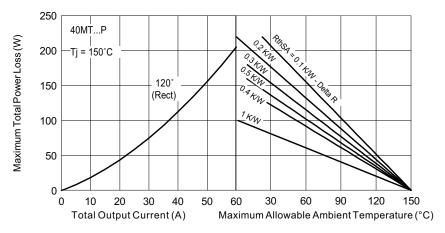


Fig. 5 - Current Rating Nomogram (1 Module Per Heatsink)

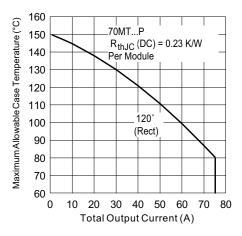


Fig. 6 - Current Rating Characteristics

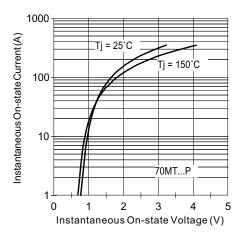


Fig. 7 - On-State Voltage Drop Characteristics

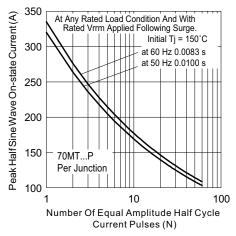


Fig. 8 - Maximum Non-Repetitive Surge Current

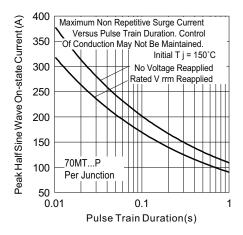


Fig. 9 - Maximum Non-Repetitive Surge Current

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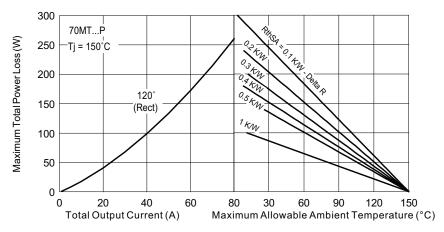


Fig. 10 - Current Rating Nomogram (1 Module Per Heatsink)

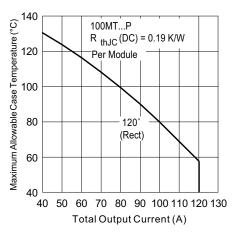


Fig. 11 - Current Rating Characteristics

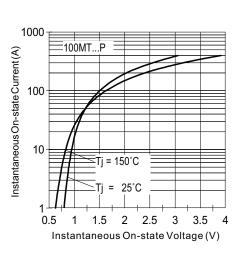


Fig. 12 - On-State Voltage Drop Characteristics

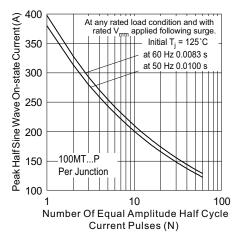


Fig. 13 - Maximum Non-Repetitive Surge Current

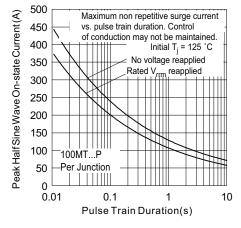


Fig. 14 - Maximum Non-Repetitive Surge Current

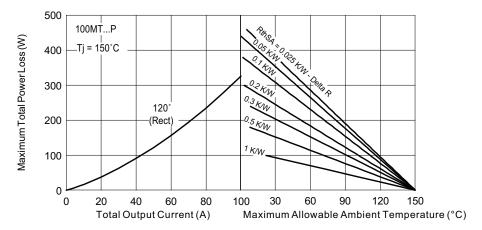


Fig. 15 - Current Rating Nomogram (1 Module Per Heatsink)

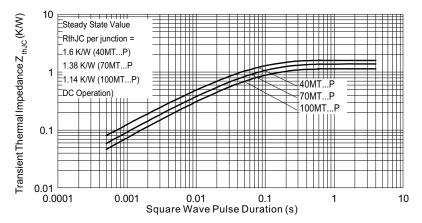
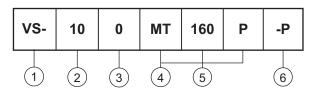


Fig. 16 - Thermal Impedance Z_{thJC} Characteristics

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ORDERING INFORMATION TABLE

Device code



1 - Vishay Semiconductors product

2 - Current rating code - 4 = 45 A 7 = 75 A 10 = 100 A

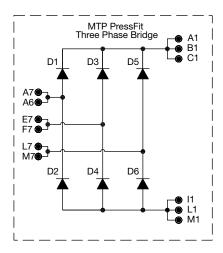
3 - Circuit configuration code: 0 = Three Phase Bridge

4 - Package indicator

5 - Voltage code x 10 = V_{RRM} (see Voltage Ratings table)

6 - Pinout code (PressFit pins)

CIRCUIT CONFIGURATION



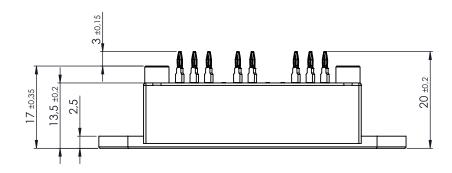
LINKS TO RELATED DOCUMENTS				
Dimensions	www.vishay.com/doc?95595			

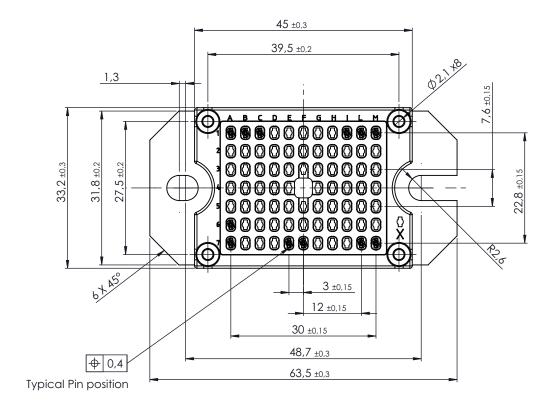


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MTP Three Phase PressFit

DIMENSIONS in millimeters









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